Curriculum Vitae

Abraham Gonzalez

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Education

Ph.D. — Electrical Engineering and Computer Science

Aug. 2018

University of California at Berkeley

Bachelors of Science — Electrical Engineering

Aug. 2014 - May 2018

The University of Texas at Austin

GPA — Overall: 3.98/4.00 Major: 3.98/4.00

Relevant Coursework

Computer Engineering — Computer Architecture, Digital Systems Design Using HDL, Embedded Systems Design Lab, Real-time Operating Systems, Digital Logic Design, Software Design I & II, Algorithms, and Honors Engineering Design I & II.

Electrical Engineering — Electric Circuits Lab, Solid State Electronic Devices, Electromagnetic Engineering, Circuit Theory, Intro to Probability, and Engineering Communication.

Experience

Scalable Performance CPU Development Group Intern

May 2018 - Aug. 2018

Intel — Austin, TX

- Worked on debugging tools for microcontroller integration team.
- Helped setup infrastructure between firmware team and microcontroller integration team to speed up work.

Microsystems Technology Lab Intern

Jun. 2017 - Aug. 2017

Massachusetts Institute of Technology — Cambridge, MA

- Researched variations in electroplating growth in redistribution layers under the supervision of Dr. Boning.
- Designed various neural networks and machine learning models for electroplating growth using Tensorflow.
- Presented final research poster summarizing work and participated in multiple MITSRP workshops.

Printing Electronics Research Assistant

Jan. 2017 - Jun. 2017

The University of Texas at Austin — Austin, TX

- Researched and fabricated printed antennas under the supervision of Dr. Chen.
- Printed and tested fixed PAA antennas on Kapton with various nano-particle inks.

QCA Research Assistant

May 2015 - Aug. 2016

The University of Texas at Austin — Austin, TX

- Researched and designed Quantum Cellular Automata (QCA) circuitry with Dr. Swartzlander.
- Optimized QCA implementations of the Carry-Lookahead and Conditional Sum adder through QCA Designer.
- Reported back to Dr. Swartzlander on results and improvements to QCA circuit designs and layouts.

Office Shared Graphics Explore Intern

May 2016 - Aug. 2016

Microsoft — Redmond, WA

- Created and added new features to the Office Ink suite using C++.
- Investigated new feature sets with other Microsoft Program Managers and customers.
- Created physical network of Arduino microcontrollers for OneWeek Hack-a-thon that once connected to each other sent a unique code to the main server (HTTP requests).
- Collaborated with senior engineers and engineers on software design and implementation.

UIM Driver Intern

May 2015 - Aug. 2015

Qualcomm — San Diego, CA

- Designed software framework for smartcard interaction in C++/CLI and C++.
- Integrated designed framework into .NET application managing smartcards via CCID by utilizing APDU transmission and logging; file system viewing; file data parsing and manipulation; and smartcard reader management.
- Communicated with engineers on software design and implementation.
- Created gesture controlled car with Particle Core for Hack-Mobile Hack-a-thon.

Electronic Cooling Research Lab Assistant

Jun. 2012

Villanova University — Villanova, PA

• Participated in constructing and remodeling a cooling test mechanism.

- Investigated techniques to cool spherical devices within a wind tunnel.
- Communicated with Ph.D. students and Masters students.

Conferences

Society of Hispanic Professional Engineers National Conference

Nov. 2017

Society of Hispanic Professional Engineers — Kansas City, MO

- Participated and won the 2nd place award in the Engineering Science Symposium (ESS) Poster Competition.
- Selected as 1 of about 40 students nationally for ESS Poster Competition.
- Attended Engineering Science Symposium Oral Presentations and workshops.

Supercomputing Conference - SC15

Nov. 2015

Tezzaron Semiconductor — Austin, TX

- Worked with the Tezzaron company booth as an usher during exhibit fair.
- Networked with other high performance computing (HPC) companies.

Qualcomm DECA Conference

Jan. 2015 - Feb. 2015

Qualcomm — San Diego, CA

- \bullet Developed professional and social skills through mock interviews and workshops.
- Participated and won Qualcomm QHack.
- Selected as 1 of 51 students nationally for DECA Conference.

Presentations

Capstone Design Showcase

Nov. 20, 2017

The University of Texas at Austin — Austin, TX

• Project Presented: Enhancing an Out-of-Order Processor Simulator for Cloud Applications.

Engineering Science Symposium Poster Session

Nov. 3, 2017

Society of Hispanic Professional Engineers National Conference — Kansas City, MO

- Research Presented: A Machine Learning Approach to Modeling Electroplating Process Variations in IC Redistribution Layers.
- Awarded 2nd Place in Engineering Science Symposium Poster Competition.

MITSRP Poster Session

Aug. 10, 2017

Massachusetts Institute of Technology — Cambridge, MA

• Research Presented: A Machine Learning Approach to Modeling Electroplating Process Variations in IC Redistribution Layers.

Projects

Enhancing an Out-of-Order Processor Simulator for Cloud Applications — Capstone Project

- Designed and developed new software data-structures for emulating simultaneous multithreading on ZSim.
- Worked with an out-of-order processor pipeline to introduce new hardware scheduling schemes to ensure quality of service for latency critical tasks.
- Presented a poster of final results at The University of Texas Electrical Engineering Spring Open House.

Bounce Music App for Android — Individual Project

- Designed and developed an app in which a user can stream music to multiple phones within the same vicinity.
- Used Spotify API to access and display a catalog of music and sockets for basic connection capabilities.

Skills

${\bf Programming\ Languages} - \\$

- Highly Proficient: C, C++, C++/CLI, Python, TensorFlow, Verilog, VHDL, Git, and LC-3 Assembly.
- Proficient: ARM Assembly, Android Java, C#, and Subversion.

 ${\bf \textit{Embedded Systems} - \text{Tiva Launchpad, Arduino, SparkFun, and Particle Core microcontrollers.}$

Electrical Equipment — Soldering, oscilloscopes, logic analyzers, and multimeters.

Professional Leadership and Membership

Vice President — Eta Kappa Nu Electrical Engineering Honor SocietyFall 2017 - Spring 2018Corresponding Secretary — Eta Kappa Nu Electrical Engineering Honor SocietySummer 2017 - Fall 2017Member — Eta Kappa Nu Electrical Engineering Honor SocietySpring 2016 - PresentMember — Institute of Electrical and Electronic EngineersFall 2014 - PresentMember — Society of Hispanic Professional Engineers (SHPE)Fall 2014 - PresentPi Tutor — Equal Opportunity in Engineering (EOE)Fall 2015, Fall 2017Academic Director — Society of Hispanic Professional EngineersSummer 2016 - Summer 2017

Organizing Committee Member — 3 Day Startup Austin

Fall 2014 - Fall 2015

Participant — 3 Day Startup Austin

Fall 2014

Honors and Awards

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EECS Excellence Award — University of Califonia at Berkeley	Fall 2018
Berkeley Fellowship for Graduate Study — University of Califonia at Berkeley	Fall 2018
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Highest Honors — The University of Texas at Austin	Spring 2018
Distinguished College Scholar — The University of Texas at Austin	Spring 2018
Academic Leader Hall of Fame Inductee — Equal Opportunity in Engineering Program	Spring 2018
Roberto Rocca Scholarship Recipient — Tenaris	Fall 2017
Second-Place Award Winner — SHPE National Conference Poster Competition	Fall 2017
Distinguished College Scholar — The University of Texas at Austin	Spring 2017
Victor L. Hand Scholarship Recipient — Victor L. Hand Endowed Scholarhip Fund	Fall 2016
College Scholar — The University of Texas at Austin	Spring 2016
Diversity Scholarship Recipient — Texas Instruments	Fall 2015
Freshman Academic Excellence Award Winner — EOE and SHPE	Spring 2015